

Key Design Points

- Use K_{RP} (ripple-to-peak current ratio) in the range of 0.4 to 0.6 and V_{OR} (output reflected voltage) of 90 V to 110 V for best efficiency.
- Use low cost optocoupler - gain is non-critical.
- PCB traces which carry high switching voltages and current should be short and wide to reduce EMI.
- Reduce leakage inductance by filling each winding layer across the entire width of the bobbin.
- R4 should be large enough to limit dissipation, to meet <300 mW no-load target, while still limiting peak DRAIN voltage to a safe value – 200 k Ω is a good start value for most designs.
- A layer of insulation tape between each layer of primary winding will further reduce inter-winding capacitance and therefore switching losses.
- Ferrite bead L2 reduces radiated EMI.

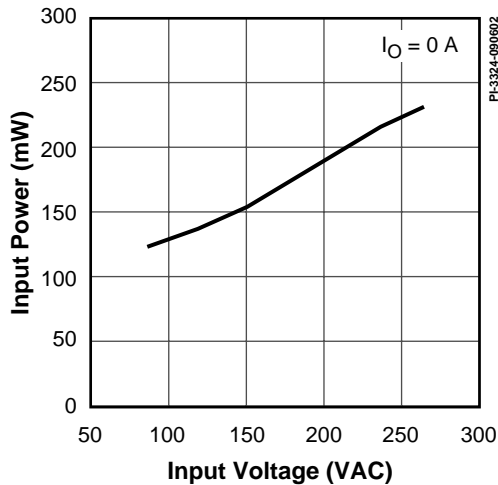


Figure 2. No-load Input Power Consumption.

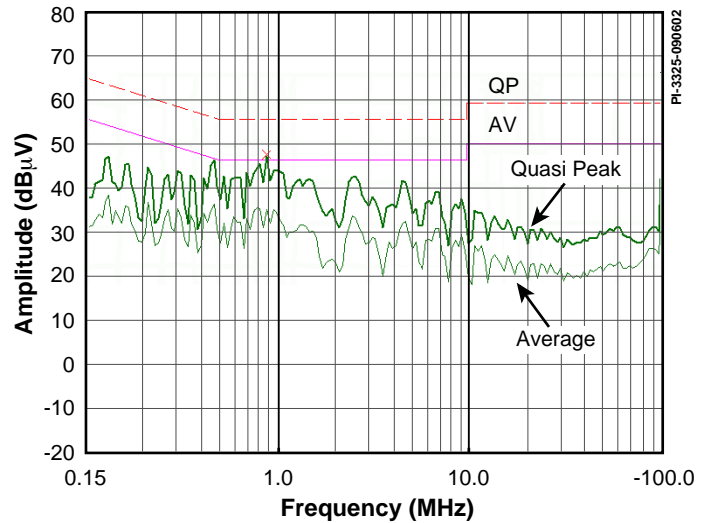


Figure 3. Conducted Emissions-EN55022 Class B (QP and AVG), 5 V, 1 A, 230 VAC, with Artificial Hand Connected to Secondary Return.

TRANSFORMER PARAMETERS	
Core	EE16, Nippon Ceramic NC-2H or equivalent, $A_L = 135 \text{ nH/T}^2$
Bobbin	EEL16 Vertical
Winding Order (pin numbers)	Shield (1-NC), Primary (4-1), Shield (3-2), and Secondary (10-8).
Primary Inductance (Pins 1-4 all others open)	1660 $\mu\text{H} \pm 10\%$
Primary Resonant Frequency (Pins 1-4, all other open)	400 kHz (minimum)
Leakage Inductance (Pins 1-4, with Pins 8-14 shorted)	70 μH (maximum)

Table 1. Transformer Design Parameters.

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